

Supplemental Information

This notice describes the differences between the updated version and its previous version of the IDT82V2048L Data Sheet. It helps readers to identify the changes when the data sheet is upgraded.

Revision History

Revision Date	PCN Number (if applicable)	Date Code	Changed Items
July 29, 2005	-	-	28 - 1

Changed Items

July 29, 2005

- Item 28:** Added IDT Green package options for PBGA and TQFP. (Page 1, 48)
- Item 27:** Updated MCn pin description in Table-1 'Pin Description'. (Page 9)
- Item 26:** Updated the description of TCK pin and added TDO pin in Table-1 'Pin Description'. (Page 9, 10)
- Item 25:** Updated T1 VDDT supply specification in Table-1 'Pin Description', Table-6 'External Component Values', section 'Transmit Driver Power Supply' and 'Recommended Operating Conditions' table and 'Power Consumption' table. (Page 10, 15, 35, 36)
- Item 24:** Updated the description of CLKE pin for RDPn, RDNn, SCLK and SDO pins in Table-1 'Pin Description', and section 'Clock Edges'; updated Table-3 'Active Clock Edge and Active Level' (Page 4, 5, 7, 8, 13)
- Item 23:** Updated LOS declare/clear value in Table-4 'LOS Condition' and Table 'Receiver Characteristics'; added a note in Table-4 'LOS Condition'. (Page 13, 38)
- Item 22:** Updated section 'Power Driver Failure Monitor'. (Page 15)
- Item 21:** Added 'Transmit Line Side Short Circuit' section. (Page 15)
- Item 20:** Updated section 'Reset' and changed the headline 'Reset' into 'Software Reset'. (Page 17)
- Item 19:** Updated section 'Power Up' and changed the headline 'Power Up' into 'Power on Reset'. (Page 17)
- Item 18:** Updated section 'Interrupt Handling' and 'Register List and Map'. (Page 19, 20)
- Item 17:** Updated section 'Reserved and Test Registers'. (Page 20)
- Item 16:** Added Remote Loopback option in section 'G.772 Monitoring', 'Register List and Map', Table-9 'Primary Register List' and Table-11 'Primary Register Map'. (Page 16, 20, 22)
- Item 15:** Updated bit 0-7 description of register 'GCF' and 'OE' in Table-11 'Primary Register Map'. (Page 22, 23)
- Item 14:** Removed a note about register 'DF'. (Page 25)
- Item 13:** Updated the description of register 'e-AFE'. (Page 28)
- Item 12:** Updated bit #85 from 'RDN5' to 'RDN6' and bit #87 from 'HZEN' to 'HZEN6' in Table-15 'Boundary Scan Register Description'. (Page 32)
- Item 11:** Updated 'lin' section in 'Absolute Maximum Rating' table. (Page 35)
- Item 10:** Updated typical 'Isc' value and Note 3 in 'Transmitter Characteristics' table. (Page 37)
- Item 9:** Changed the table title from 'DC Characteristics' to 'Receiver Characteristics'. (Page 38)
- Item 8:** Extended 'IA' value and 'SIR' value; changed Note 2 in 'Receiver Characteristics' table (Page 38)
- Item 7:** Changed the unit for 'SRE' from 'dB' to '%' in 'Receiver Characteristics' table. (Page 38)
- Item 6:** Updated Note 1 and 2; removed Note 3 and 4 from 'Transceiver Timing Characteristics' table. (Page 39)
- Item 5:** Updated MCLK frequency in 'Transceiver Timing Characteristics' table. (Page 39)

- Item 4:** Updated receive path timing 't4' to 't9' in 'Transceiver Timing Characteristics' table; updated Figure-15 Receive System Interface Timing. (Page 39, 40)
- Item 3:** Changed 'A[7:0]' into 'A[4:0]' for non-multiplexed read/write timing in Figure-17, Figure-19, Figure-21 and Figure-23. (Page 43, 44, 45, 46)
- Item 2:** Updated 't8' and 't9' timing in Figure-22 'Multiplexed Motorola Mode Read Timing'. (Page 45)
- Item 1:** Changed 't10' value in 'Serial Host Interface Timing Characteristics' table and added 't10' in Serial Interface Read Timing figures Figure-26 and Figure-27. (Page 47)

Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
4. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.
 - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.
6. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
7. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
9. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
10. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
11. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.

(Note1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.

(Note2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.4.0-1 November 2017)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan
www.renesas.com

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:
www.renesas.com/contact/

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.